

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	953642	semiconduct\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:29
L2	1366070	semiconduct\$3 or silicon	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:29
L3	77741	interlevel or interlayer	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:29
L4	1489398	dielectric or insulat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:29
L5	592772	sacrificial\$3 or removable	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:30
L6	1505861	transmissi\$3 or microstrip\$4 or waveguide\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:31
L7	44086	metallizat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:33
L8	371261	(plurality or array\$1) near5 (hole\$1 or opening\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:35
L9	10536	etch\$3 with 5	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:35
L10	47928	3 with 4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:36

L11	2539761	air	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:37
L12	3109117	(cavity or cavities or gap\$1 or groove\$1 or trench\$2 or recess\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:38
L13	5	2 and 8 and 9 and 10 and (11 same 12) and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:39
L14	104	2 and 8 and 9 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:40
L15	9	14 and 12 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:42
L16	95	14 not (13 or 15)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/07/25 10:42